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1. Name of conveying party(ies) ALAN G. WOOD TIM CORBETT	2. Name and address of receiving party(ies) Name: MICRON TECHNOLOGY, INC. Internal Address:	
Additional name(s) of conveying party(ies) attached? Yes No. 3. Nature of conveyance/Execution Date(s): Execution Date(s) April 13, 2009 Assignment Merger Security Agreement Change of Name Joint Research Agreement Government Interest Assignment Executive Order 9424, Confirmatory License Other 4. Application or patent number(s): This A. Patent Application No.(s)	Street Address:ggog South Federal Way	
12/424,726	nahada Tyon Whia	
Additional numbers attached? Yes XNo 5. Name and address to whom correspondence 6. Total number of applications and patents		
concerning document should be mailed:	involved:	
Name: Stephen A. Gratton Internal Address: LAW OFFICE OF STEPHEN A. GRATTON	7. Total fee (37 CFR 1.21(h) & 3.41) \$_40.00	
Street Address: _{2764 South Braun Way}	Enclosed None required (government interest not affecting title)	
City: Lakewood	8. Payment Information	
State: Zip ₈₀₂₂₈	·	
Phone Number: 303 989 6353 Fax Number: 303 989 6538 Email Address: grattonstephen@qwest.net	Deposit Account Number	
9. Signature: Stephen A. Gratton Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:	

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PATENT REEL: 022576 FRAME: 0866

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re a	pplication of:		
	ALAN G. WOOD TIM CORBETT		
Serial	No.: 12/424,726		
Filing	Date: Concurrently Herev	vith	
Title:	itle: THINNED SEMICONDUCTOR COMPONENTS HAVING LASERED FEATURES AND METHODS FOR FABRICATING SEMICONDUCTOR COMPONENTS USING BACK SIDE LASER PROCESSING		
Docke	et No. 2008-0738.00		
		ASSIGNMENT:	
<u>x</u> _	Enclosed for recording Previously recorded		
Date:		_	
Reel:			

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency, and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN, AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83707-0006, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which will be executed by the undersigned and is entitled: THINNED SEMICONDUCTOR COMPONENTS HAVING LASERED FOR FABRICATING SEMICONDUCTOR **FEATURES** AND METHODS COMPONENTS USING BACK SIDE LASER PROCESSING; such application and all divisional, continuing, substitute, renewal, reissue, and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

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AUTHORIZE AND REQUEST, the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney, and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining, and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives, and successors of the undersigned and extend to the successors, assigns, and nominees of the Assignee.

STATE OF IDAHO

COUNTY OF ADA

BEFORE ME, this day of day of

}ss.

Notary or Consular Officer of the

Notary of Consular Officer of t

United States of America

My Commission Expires: φ 27 (1)

MICRON TECHNOLOGY, INC.

DOCKET NO. 2008-0738.00/US

STATE OF IDAHO

(Signature)

}ss.

COUNTY OF ADA

BEFORE ME, this day of reconstruction, 2009, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.

SEAL

otary or Consular Officer of the

Date 4/13/0 9

United States of America

My Commission Expires: 6 2



DOCKET NO. 2008-0738.00/US

RECORDED: 04/21/2009

MICRON TECHNOLOGY, INC.

PATENT REEL: 022576 FRAME: 0869